


PRELIMINARY  
DESIGN IS SUBJECT  
TO CHANGE WITHOUT  
PRIOR NOTICE

REV.	Q'TY	ECN. NO.	APR.	DATE
A		FIRST RELEASE	Jason	2018.03.29

- NOTES:
- 1.Working temp:-25°C~85°C.
  - 2.Voltage rating:50V AC/DC(rms)
  - 3.Contact resistance:40mΩ max.
  - 4.Insulation resistance:100MΩ min.
  - 5.Current rating:1A AV/DC
  - 6.Withstanding Voltage:500V AC/minute
  - 7.Pin Retention Force:0.5N min.
  - 8.Housing material:PA9T UL94-V0,Natural
  - 9.Terminal materl:Brass,  
plating Ni 40u" min , plating Au 0.8u"min.
  - 10.Solder tab material:Brass,  
plating Ni 40u" min , plating Au 0.8u"min.

PIN	NO.	Dim A	Dim B
2	WF13-ON02F18N11	1.25	7.65
3	WF13-ON03F18N11	2.50	8.90
4	WF13-ON04F18N11	3.75	10.15
5	WF13-ON05F18N11	5.00	11.30
6	WF13-ON06F18N11	6.25	12.65
7	WF13-ON07F18N11	7.50	13.90
8	WF13-ON08F18N11	8.75	15.15
9	WF13-ON09F18N11	10.00	16.40
10	WF13-ON10F18N11	11.25	17.65
11	WF13-ON11F18N11	12.50	18.90
12	WF13-ON12F18N11	13.75	20.15
13	WF13-ON13F18N11	15.00	21.40
14	WF13-ON14F18N11	16.25	22.65
15	WF13-ON15F18N11	17.50	23.90
20	WF13-ON20F18N11	23.75	30.15
30	WF13-ON30F18N11	36.25	42.65

DIMENSION IN mm		山谷道	深圳市山谷道电子有限公司			
TOLERANCE UNLESS OTHERWISE SPECIFIED						
.X±0.35	X.*± 5'	APR. Alex	TITLE: WAFER PH1.25mm H1.85mm 90°SMT			
.XX±0.25	.X.*± 3'	CHK. Jack	DWG NO. WF13-0NxxF18N11			
.XXX±0.15	.XX.*± 1'	DRA. Jave	PROJ. 		CUSTOMER DRAWING	
			SIZE A4	SCALE 4:1	SHEET 1/2	REV. A

